

# TXB0304 4-Bit Bidirectional Level-Shifter/Voltage Translator with Automatic Direction Sensing

## 1 Features

- Fully Symmetric Supply Voltages, 0.9 V to 3.6 V on A Port and 0.9 V to 3.6 V
- $V_{CC}$  Isolation Feature – If Either  $V_{CC}$  Input is at GND, all Outputs are in High-Impedance State
- OE Input Circuit Referenced to  $V_{CCA}$
- Low Power Consumption, 5  $\mu$ A Max ( $I_{CCA}$  or  $I_{CCB}$ )
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 8000-V Human-Body Model (A114-B)
  - 1000-V Charged-Device Model (C101)

## 2 Applications

- Personal Electronics
- Industrial
- Enterprise
- Telecom

## 3 Description

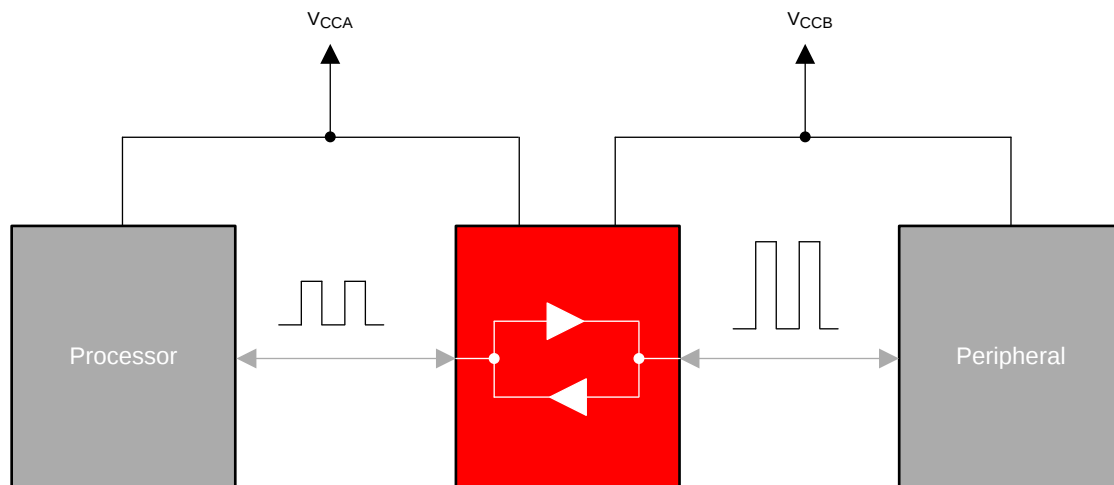
This 4-bit non-inverting translator uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 0.9 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 0.9 V to 3.6 V. This allows for low Voltage bidirectional translation between 1 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V voltage nodes. For the TXB0304, when the output-enable (OE) input is low, all outputs are placed in the high-impedance state. To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pull-down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver. The OE device control pin input circuit is supplied by  $V_{CCA}$ . This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The only difference between TXB0304 and TXBN0304 is the OE signal being active high and active low respectively.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE       | BODY SIZE (NOM)   |
|-------------|---------------|-------------------|
| TXB0304     | RUT UQFN (12) | 2.00 mm × 1.70 mm |
|             | RSV UQFN (16) | 2.60 mm × 1.80 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### Typical Application Block Diagram for TXB0304



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision F (May 2016) to Revision G                             | Page      |
|------------------------------------------------------------------------------|-----------|
| • Changed text in <a href="#">Power Supply Recommendations</a> section. .... | <b>13</b> |

| Changes from Revision E (August 2014) to Revision F                                                                                                                                                                                     | Page     |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| • Made changes to <a href="#">Description</a> section. ....                                                                                                                                                                             | <b>1</b> |
| • Made changes to <a href="#">Absolute Maximum Ratings</a> , <a href="#">Recommended Operating Conditions</a> <sup>(1)(2)</sup> , <a href="#">Switching Characteristics</a> and <a href="#">Electrical Characteristics</a> tables. .... | <b>1</b> |

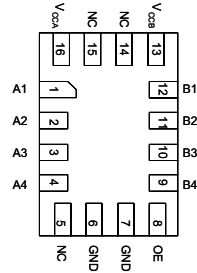
| Changes from Revision D (October 2012) to Revision E                                                                                                                                                                                                                                                                                                                                                                         | Page     |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| • Added <a href="#">ESD Ratings</a> table, <a href="#">Feature Description</a> section, <a href="#">Device Functional Modes</a> , <a href="#">Application and Implementation</a> section, <a href="#">Power Supply Recommendations</a> section, <a href="#">Layout</a> section, <a href="#">Device and Documentation Support</a> section, and <a href="#">Mechanical, Packaging, and Orderable Information</a> section. .... | <b>1</b> |
| • Changed VCCA and VCCB in the ABS MAX table to V <sub>CCA</sub> and V <sub>CCB</sub> in 3 places .....                                                                                                                                                                                                                                                                                                                      | <b>4</b> |
| • Changed in ELEC CHARAC table the 0.9 x V <sub>CCA</sub> and 0.9 x V <sub>CCB</sub> from MAX column into the MIN column .....                                                                                                                                                                                                                                                                                               | <b>5</b> |
| • Changed in ELEC CHARAC table 0.2 (2 places) in the MIN column to the MAX .....                                                                                                                                                                                                                                                                                                                                             | <b>5</b> |

| Changes from Revision C (May 2012) to Revision D              | Page      |
|---------------------------------------------------------------|-----------|
| • Added <a href="#">Application Information</a> section ..... | <b>12</b> |

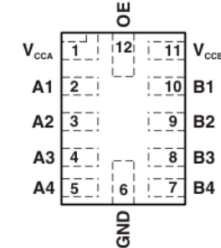
| Changes from Revision B (September 2011) to Revision C | Page     |
|--------------------------------------------------------|----------|
| • Added package pin out diagram notes. ....            | <b>3</b> |

## 5 Pin Configuration and Functions

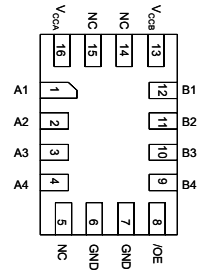
**RSV Package  
16-Pin UQFN  
TXB0304 Top View**



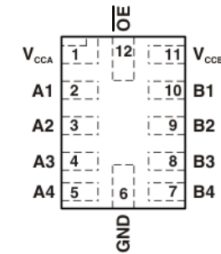
**RUT Package  
12-Pin UQFN  
TXB0304 Top View**



**RSV Package  
16-Pin UQFN  
TXBN0304 Top View**



**RUT Package  
12-Pin UQFN  
TXBN0304 Top View**



- A. See [Layout Guidelines](#) for notes about package pin out diagrams.

### Pin Functions

| PIN                    |           |     |           |     | TYPE | DESCRIPTION                                                                                                                                    |                                |
|------------------------|-----------|-----|-----------|-----|------|------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|
| NAME                   | TXB0304   |     | TXBN0304  |     |      |                                                                                                                                                |                                |
|                        | RSV       | RUT | RSV       | RUT |      |                                                                                                                                                |                                |
| A1                     | 1         | 2   | 1         | 2   | I/O  | Input/output 1                                                                                                                                 | Referenced to V <sub>CCA</sub> |
| A2                     | 2         | 3   | 2         | 3   | I/O  | Input/output 2                                                                                                                                 |                                |
| A3                     | 3         | 4   | 3         | 4   | I/O  | Input/output 3                                                                                                                                 |                                |
| A4                     | 4         | 5   | 4         | 5   | I/O  | Input/output 4                                                                                                                                 |                                |
| B1                     | 12        | 10  | 12        | 10  | I/O  | Input/output 4                                                                                                                                 | Referenced to V <sub>CCB</sub> |
| B2                     | 11        | 9   | 11        | 9   | I/O  | Input/output 3                                                                                                                                 |                                |
| B3                     | 10        | 8   | 10        | 8   | I/O  | Input/output 2                                                                                                                                 |                                |
| B4                     | 9         | 7   | 9         | 7   | I/O  | Input/output 1                                                                                                                                 |                                |
| GND                    | 6, 7      | 6   | 6,7       | 6   | GND  | Ground                                                                                                                                         |                                |
| NC                     | 5, 14, 15 | —   | 5, 14, 15 | —   | —    | No connection; not internally connected                                                                                                        |                                |
| OE                     | 8         | 12  | —         | —   | I    | 3-state output-mode enable. Pull OE (TXB0304) low to place all outputs in 3-state mode. Referenced to V <sub>CCA</sub> .                       |                                |
| $\overline{\text{OE}}$ | —         | —   | 8         | 12  | I    | 3-state output-mode enable. Pull $\overline{\text{OE}}$ (TXBN0304) high to place all outputs in 3-state mode. Referenced to V <sub>CCA</sub> . |                                |
| V <sub>CCA</sub>       | 16        | 1   | 16        | 1   | —    | A-port supply voltage 0.9 V ≤ V <sub>CCA</sub> ≤ 3.6 V                                                                                         |                                |
| V <sub>CCB</sub>       | 13        | 11  | 13        | 11  | —    | B-port supply voltage 0.9 V ≤ V <sub>CCB</sub> ≤ 3.6 V                                                                                         |                                |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                                                                         |                                                                        |                    | MIN  | MAX                    | UNIT |
|-------------------------------------------------------------------------|------------------------------------------------------------------------|--------------------|------|------------------------|------|
| V <sub>CCA</sub>                                                        | Supply voltage                                                         |                    | −0.5 | 4.6                    | V    |
| V <sub>CCB</sub>                                                        |                                                                        |                    | −0.5 | 4.6                    |      |
| V <sub>I</sub>                                                          | Input voltage                                                          | A port             | −0.5 | 4.6                    | V    |
|                                                                         |                                                                        | B port             | −0.5 | 4.6                    |      |
| V <sub>O</sub>                                                          | Voltage applied to any output in the high-impedance or power-off state | A port             | −0.5 | 4.6                    | V    |
|                                                                         |                                                                        | B port             | −0.5 | 4.6                    |      |
| V <sub>O</sub>                                                          | Voltage applied to any output in the high or low state <sup>(2)</sup>  | A port             | −0.5 | V <sub>CCA</sub> + 0.5 | V    |
|                                                                         |                                                                        | B port             | −0.5 | V <sub>CCB</sub> + 0.5 |      |
| I <sub>IK</sub>                                                         | Input clamp current                                                    | V <sub>I</sub> < 0 |      | −50                    | mA   |
| I <sub>OK</sub>                                                         | Output clamp current                                                   | V <sub>O</sub> < 0 |      | −50                    | mA   |
| I <sub>O</sub>                                                          | Continuous output current                                              |                    |      | ±50                    | mA   |
| Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND |                                                                        |                    |      | ±100                   | mA   |
| T <sub>stg</sub>                                                        | Storage temperature                                                    |                    | −65  | 150                    | °C   |
| T <sub>J</sub>                                                          | Junction temperature                                                   |                    | −40  | 125                    | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The value of V<sub>CCA</sub> and V<sub>CCB</sub> are provided in the recommended operating conditions table.

### 6.2 ESD Ratings

|                    |                         | VALUE                                                                                    | UNIT  |
|--------------------|-------------------------|------------------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ±8000 |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ±1000 |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions <sup>(1)(2)</sup>

|                     |                                                                              |                            | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN                     | MAX                     | UNIT |
|---------------------|------------------------------------------------------------------------------|----------------------------|------------------|------------------|-------------------------|-------------------------|------|
| V <sub>CCA</sub>    | Supply voltage                                                               |                            |                  |                  | 0.9                     | 3.6                     | V    |
| V <sub>CCB</sub>    |                                                                              |                            |                  |                  |                         |                         |      |
| V <sub>IH</sub>     | High-level input voltage                                                     | Data inputs                | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   | V <sub>CCI</sub> × 0.65 | V <sub>CCI</sub>        | V    |
|                     |                                                                              | OE/ $\overline{\text{OE}}$ | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   | V <sub>CCA</sub> × 0.65 | 3.6                     |      |
| V <sub>IL</sub>     | Low-level input voltage                                                      | Data inputs                | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   | 0                       | V <sub>CCI</sub> × 0.35 | V    |
|                     |                                                                              | OE/ $\overline{\text{OE}}$ | 0.9 V to 1.2 V   | 0.9 V to 3.6 V   | 0                       | V <sub>CCA</sub> × 0.3  |      |
|                     |                                                                              |                            | 1.2 V to 3.6 V   | 0.9 V to 3.6 V   | 0                       | V <sub>CCA</sub> × 0.35 |      |
| V <sub>O</sub>      | Voltage range applied to any output in the high-impedance or power-off state | A-port                     | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   | 0                       | 3.6                     | V    |
|                     |                                                                              | B-port                     | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   | 0                       | 3.6                     |      |
| $\Delta t/\Delta v$ | Input transition rise or fall rate                                           | A-port inputs              | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   |                         | 40                      | ns/V |
|                     |                                                                              | B-port inputs              | 0.9 V to 3.6 V   | 0.9 V to 3.6 V   |                         | 40                      |      |
| T <sub>A</sub>      | Operating free-air temperature                                               |                            |                  |                  | −40                     | 85                      | °C   |

- (1) The A and B sides of an unused data I/O pair must be held in the same state, such as, both at V<sub>CCI</sub> or both at GND.
- (2) V<sub>CCI</sub> is the supply voltage associated with the input port.

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TXB0304    |            | UNIT |
|-------------------------------|----------------------------------------------|------------|------------|------|
|                               |                                              | RUT (UQFN) | RSV (UQFN) |      |
|                               |                                              | 12 PINS    | 16 PINS    |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 116.4      | 131.7      | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 45.7       | 55.8       | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 46.9       | 55.3       | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.6        | 1.4        | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 46.9       | 55.3       | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER           |                             | TEST CONDITIONS                              |                                                     | $V_{CCA}$      | $V_{CCB}$      | MIN                  | TYP | MAX                | UNIT    |
|---------------------|-----------------------------|----------------------------------------------|-----------------------------------------------------|----------------|----------------|----------------------|-----|--------------------|---------|
| $V_{OHA}$           | High-level output voltage   | $I_{OH} = -20 \mu A$                         | $T_A = 25^\circ C$                                  | 0.9 V to 3.6 V |                | $0.9 \times V_{CCA}$ |     |                    | V       |
| $V_{OLA}$           | Low-level output voltage    | $I_{OL} = 20 \mu A$                          | $-40^\circ C$ to $85^\circ C$                       | 0.9 V to 3.6 V |                |                      |     | 0.2                | V       |
| $V_{OHB}$           | High-level output voltage   | $I_{OH} = -20 \mu A$                         | $T_A = 25^\circ C$                                  |                | 0.9 V to 3.6 V | $0.9 \times V_{CCB}$ |     |                    | V       |
| $V_{OLB}$           | Low-level output voltage    | $I_{OL} = 20 \mu A$                          | $-40^\circ C$ to $85^\circ C$                       |                | 0.9 V to 3.6 V |                      |     | 0.2                | V       |
| $I_I$               | OE                          | $V_I = V_{CCI}$ or GND                       | $T_A = 25^\circ C$<br>$-40^\circ C$ to $85^\circ C$ | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | $\pm 1$<br>$\pm 2$ | $\mu A$ |
| $I_{off}$           | A port                      | $V_I$ or $V_O = 0$ to 3.6 V                  | $T_A = 25^\circ C$<br>$-40^\circ C$ to $85^\circ C$ | 0 V            | 0 V to 3.6 V   |                      |     | $\pm 1$<br>$\pm 2$ | $\mu A$ |
|                     |                             |                                              | $T_A = 25^\circ C$<br>$-40^\circ C$ to $85^\circ C$ |                |                |                      |     | $\pm 1$<br>$\pm 2$ |         |
|                     | B port                      | $V_I$ or $V_O = 0$ to 3.6 V                  | $T_A = 25^\circ C$<br>$-40^\circ C$ to $85^\circ C$ | 0.9 V to 3.6 V | 0 V            |                      |     | $\pm 1$<br>$\pm 2$ |         |
|                     |                             |                                              | $T_A = 25^\circ C$<br>$-40^\circ C$ to $85^\circ C$ |                |                |                      |     | $\pm 1$<br>$\pm 2$ |         |
| $I_{OZ}$            | A or B port                 | OE = GND                                     | $T_A = 25^\circ C$<br>$-40^\circ C$ to $85^\circ C$ | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | $\pm 1$<br>$\pm 2$ | $\mu A$ |
| $I_{CCA}$           |                             | $V_I = V_{CCI}$ or GND, $I_O = 0$            | $-40^\circ C$ to $85^\circ C$                       | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 5                  | $\mu A$ |
| $I_{CCB}$           |                             | $V_I = V_{CCB}$ or GND, $I_O = 0$            | $-40^\circ C$ to $85^\circ C$                       | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 5                  | $\mu A$ |
| $I_{CCA} + I_{CCB}$ |                             | $V_I = V_{CCI}$ or GND, $I_O = 0$            | $-40^\circ C$ to $85^\circ C$                       | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 10                 | $\mu A$ |
| $I_{CCZA}$          | High-Z state supply current | $V_I = V_{CCI}$ or GND, $I_O = 0$ , OE = GND | $-40^\circ C$ to $85^\circ C$                       | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 5                  | $\mu A$ |
| $I_{CCZB}$          | High-Z state supply current | $V_I = V_{CCB}$ or GND, $I_O = 0$ , OE = GND | $-40^\circ C$ to $85^\circ C$                       | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 5                  | $\mu A$ |
| $C_i$               | OE                          | $T_A = 25^\circ C$                           |                                                     | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 3                  | pF      |
| $C_{io}$            | A port                      | $T_A = 25^\circ C$ , OE = GND                |                                                     | 0.9 V to 3.6 V | 0.9 V to 3.6 V |                      |     | 6.7                | pF      |
|                     | B port                      |                                              |                                                     |                |                |                      |     | 6.7                |         |

## 6.6 Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | LOAD                    | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN | MAX | UNIT |
|-----------|-------------------------|------------------|------------------|-----|-----|------|
| Data rate | C <sub>L</sub> = 15 pF  | 0.9 to 3.6 V     | 0.9 to 3.6 V     |     | 50  | Mbps |
|           | C <sub>L</sub> = 15 pF  | 1.2 to 3.6 V     | 1.2 to 3.6 V     |     | 100 | Mbps |
|           | C <sub>L</sub> = 15 pF  | 1.8 to 3.6 V     | 1.8 to 3.6 V     |     | 140 | Mbps |
|           | C <sub>L</sub> = 30 pF  | 0.9 to 3.6 V     | 0.9 to 3.6 V     |     | 40  | Mbps |
|           | C <sub>L</sub> = 30 pF  | 1.2 to 3.6 V     | 1.2 to 3.6 V     |     | 90  | Mbps |
|           | C <sub>L</sub> = 30 pF  | 1.8 to 3.6 V     | 1.8 to 3.6 V     |     | 130 | Mbps |
|           | C <sub>L</sub> = 50 pF  | 1.2 to 3.6 V     | 1.2 to 3.6 V     |     | 80  | Mbps |
|           | C <sub>L</sub> = 50 pF  | 1.8 to 3.6 V     | 1.8 to 3.6 V     |     | 120 | Mbps |
|           | C <sub>L</sub> = 100 pF | 1.2 to 3.6 V     | 1.2 to 3.6 V     |     | 70  | Mbps |
|           | C <sub>L</sub> = 100 pF | 1.8 to 3.6 V     | 1.8 to 3.6 V     |     | 100 | Mbps |

## 6.7 Switching Characteristics

over operating free-air temperature range (unless otherwise noted). (For parameter descriptions, see [Figure 2](#) and [Figure 3](#).)

| PARAMETER                         | FROM<br>(INPUT)            | TO<br>(OUTPUT) | LOAD                 | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN  | TYP <sup>(1)</sup> | MAX  | UNIT |
|-----------------------------------|----------------------------|----------------|----------------------|------------------|------------------|------|--------------------|------|------|
| t <sub>pd</sub>                   | A                          | B              | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          | 18.9 |                    | 30   | ns   |
|                                   | A                          | B              | C <sub>L</sub> = 15  | 1.2-3.6          | 1.2-3.6          | 7.5  |                    | 11.5 |      |
|                                   | A                          | B              | C <sub>L</sub> = 15  | 1.8-3.6          | 1.8-3.6          | 3.7  |                    | 4.8  |      |
|                                   | A                          | B              | C <sub>L</sub> = 30  | 0.9-3.6          | 0.9-3.6          | 19.5 |                    | 34   |      |
|                                   | A                          | B              | C <sub>L</sub> = 30  | 1.2-3.6          | 1.2-3.6          | 7.8  |                    | 11.9 |      |
|                                   | A                          | B              | C <sub>L</sub> = 30  | 1.8-3.6          | 1.8-3.6          | 3.8  |                    | 5.2  |      |
|                                   | A                          | B              | C <sub>L</sub> = 50  | 1.2-3.6          | 1.2-3.6          | 8    |                    | 12.3 |      |
|                                   | A                          | B              | C <sub>L</sub> = 50  | 1.8-3.6          | 1.8-3.6          | 4    |                    | 5.4  |      |
|                                   | A                          | B              | C <sub>L</sub> = 100 | 1.2-3.6          | 1.2-3.6          | 8.6  |                    | 13.5 |      |
|                                   | A                          | B              | C <sub>L</sub> = 100 | 1.8-3.6          | 1.8-3.6          | 4.5  |                    | 6    |      |
|                                   | B                          | A              | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          | 18.9 |                    | 30   | ns   |
|                                   | B                          | A              | C <sub>L</sub> = 15  | 1.2-3.6          | 1.2-3.6          | 7.5  |                    | 11.5 |      |
|                                   | B                          | A              | C <sub>L</sub> = 15  | 1.8-3.6          | 1.8-3.6          | 3.7  |                    | 5    |      |
|                                   | B                          | A              | C <sub>L</sub> = 30  | 0.9-3.6          | 0.9-3.6          | 19.5 |                    | 34   |      |
|                                   | B                          | A              | C <sub>L</sub> = 30  | 1.2-3.6          | 1.2-3.6          | 7.8  |                    | 11.9 |      |
|                                   | B                          | A              | C <sub>L</sub> = 30  | 1.8-3.6          | 1.8-3.6          | 3.8  |                    | 5.2  |      |
|                                   | B                          | A              | C <sub>L</sub> = 50  | 1.2-3.6          | 1.2-3.6          | 8    |                    | 12.3 |      |
|                                   | B                          | A              | C <sub>L</sub> = 50  | 1.8-3.6          | 1.8-3.6          | 4    |                    | 5.4  |      |
|                                   | B                          | A              | C <sub>L</sub> = 100 | 1.2-3.6          | 1.2-3.6          | 8.6  |                    | 13.5 |      |
|                                   | B                          | A              | C <sub>L</sub> = 100 | 1.8-3.6          | 1.8-3.6          | 4.5  |                    | 6    |      |
| t <sub>en</sub>                   | OE                         | A              | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      |                    | 262  | ns   |
|                                   |                            |                |                      | 1.2-3.6          | 1.2-3.6          |      |                    | 64   |      |
|                                   |                            |                |                      | 1.8-3.6          | 1.8-3.6          |      |                    | 37   |      |
|                                   |                            | B              | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      |                    | 332  |      |
|                                   |                            |                |                      | 1.2-3.6          | 1.2-3.6          |      |                    | 76   |      |
|                                   |                            |                |                      | 1.8-3.6          | 1.8-3.6          |      |                    | 41   |      |
| t <sub>dis</sub>                  | OE                         | A              | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      |                    | 172  | ns   |
|                                   |                            | B              | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      |                    | 169  | ns   |
| t <sub>FB</sub> , t <sub>FB</sub> | B-port rise and fall times |                | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      | 2.95               |      | ns   |
| t <sub>SA</sub> , t <sub>SA</sub> | A-port rise and fall times |                | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      | 3.1                |      | ns   |
| t <sub>SK(O)</sub>                | Channel-to-channel skew    |                | C <sub>L</sub> = 15  | 0.9-3.6          | 0.9-3.6          |      |                    | 0.15 | ns   |

(1) T<sub>A</sub> = 25°C

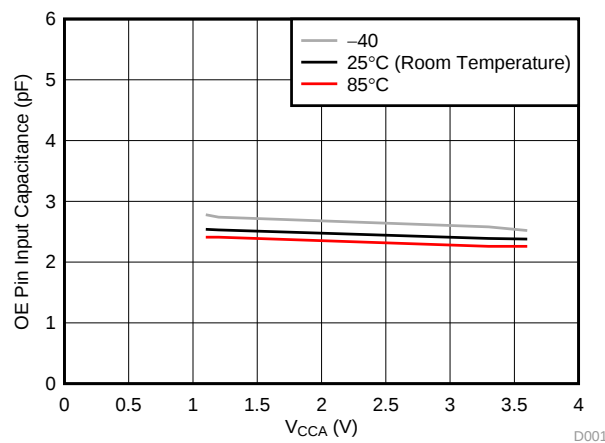
## 6.8 Operating Characteristics

$C_{pd}$  - power dissipation capacitance measured at  $T_A = 25^\circ\text{C}$ .

| PARAMETER |                             | TEST CONDITIONS                                                                                    | TYP <sup>(1)</sup> | UNIT |
|-----------|-----------------------------|----------------------------------------------------------------------------------------------------|--------------------|------|
| $C_{pdA}$ | A-port input, B-port output | $C_L = 0$ , $f = 10\text{ MHz}$ , $t_r = t_f = 1\text{ ns}$ , $OE = V_{CCA}$ (outputs enabled)     | 34                 | pF   |
|           | B-port input, A-port output |                                                                                                    | 34                 |      |
| $C_{pdB}$ | A-port input, B-port output |                                                                                                    | 34                 | pF   |
|           | B-port input, A-port output |                                                                                                    | 34                 |      |
| $C_{pdA}$ | A-port input, B-port output | $C_L = 0$ , $f = 10\text{ MHz}$ , $t_r = t_f = 1\text{ ns}$ , $OE = \text{GND}$ (outputs disabled) | 0.01               | pF   |
|           | B-port input, A-port output |                                                                                                    | 0.01               |      |
| $C_{pdB}$ | A-port input, B-port output |                                                                                                    | 0.01               | pF   |
|           | B-port input, A-port output |                                                                                                    | 0.01               |      |

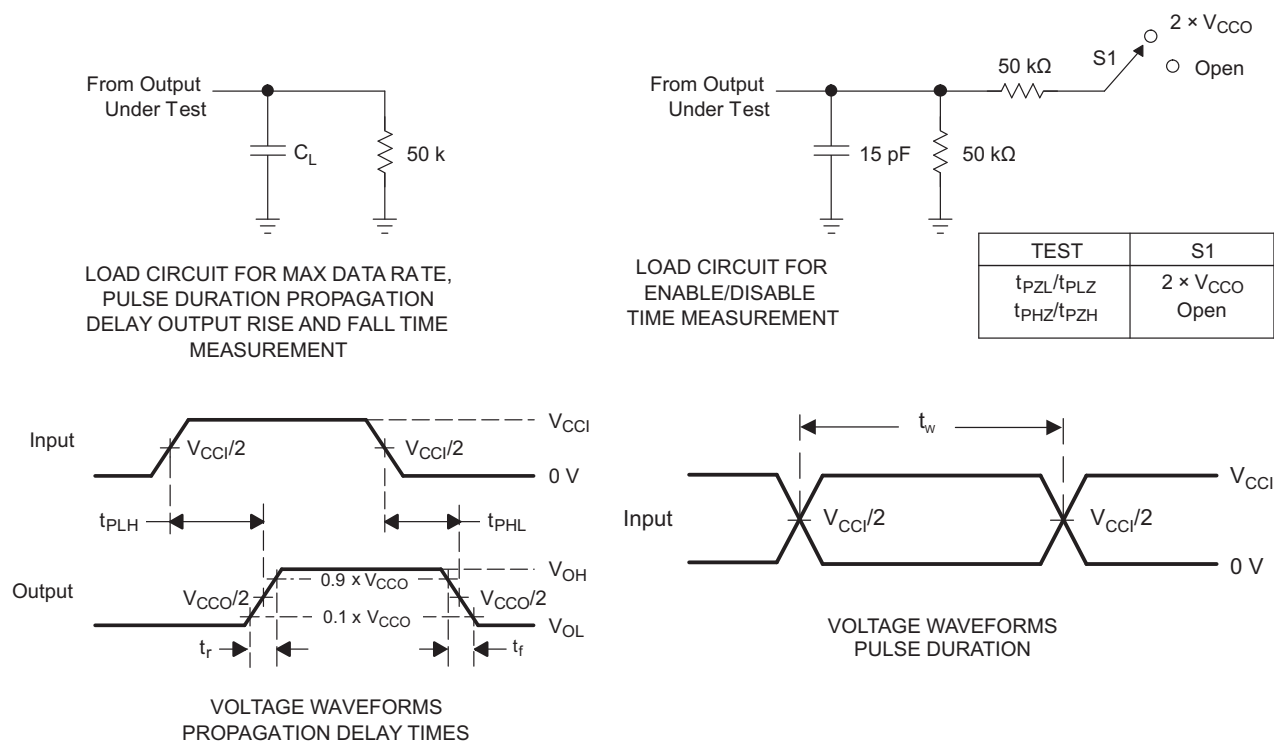
(1)  $V_{CCA}$ ,  $V_{CCB}$  0.9 V to 3.6 V

## 6.9 Typical Characteristics



**Figure 1. Input Capacitors for OE Pin ( $C_i$ ) vs Power Supply ( $V_{CCA}$ )**

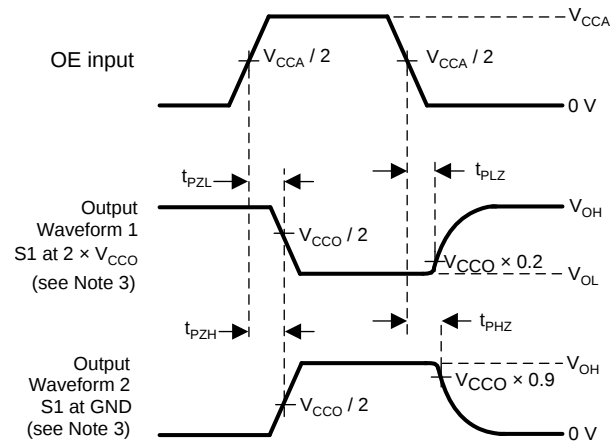
## 7 Parameter Measurement Information



- $C_L$  includes probe and jig capacitance.
- All input pulses are supplied by generators having the following characteristics: PRR 10 MHz,  $Z_O = 50 \Omega$ ,  $dv/dt \geq 1$  V/ns.
- The outputs are measured one at a time, with one transition per measurement.
- $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- $V_{CCO}$  is the  $V_{CC}$  associated with output port.
- All parameters and waveforms are not applicable to all devices.

**Figure 2. Load Circuits and Voltage Waveforms**

### Parameter Measurement Information (continued)



- (1)  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- (2)  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- (3) Waveform 1 is for an output with internal such that the output is high, except when OE is high. Waveform 2 is for an output with conditions such that the output is low, except when OE is high.

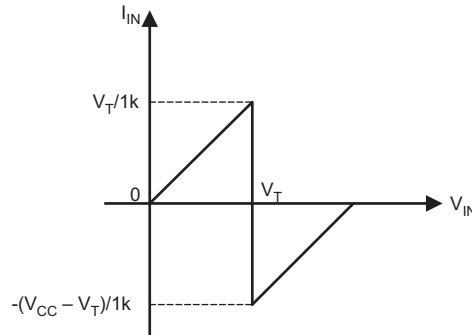
**Figure 3. Enable and Disable Times**



## 8.3 Feature Description

### 8.3.1 Input Driver Requirements

Typical  $I_{IN}$  vs  $V_{IN}$  characteristics of the TXB0304/TXBN0304 are shown in Figure 5. For proper operation, the device driving the data I/Os of the TXB0304 must have drive strength of at least  $\pm 3$  mA.



- (1)  $V_{CC}$  is power supply of TXB0304.
- (2)  $V_T$  is the input threshold voltage of TXB0304 (typically it is  $V_{CC}/2$ ).

**Figure 5. Typical  $I_{IN}$  vs  $V_{IN}$  Curve**

## 8.4 Device Functional Modes

### 8.4.1 Enable and Disable

The TXB0304 has an OE input that is used to disable the device by setting OE = low ( $\overline{OE}$  = high for TXBN0304), which places all I/Os in the high-impedance (Hi-Z) state. The disable time ( $t_{dis}$ ) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time ( $t_{en}$ ) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is high.

### 8.4.2 Pullup or Pulldown Resistor on I/O Lines

The TXB0304/TXBN0304 is designed to drive capacitive loads of up to 100 pF. The output drivers of the TXB0304 have low dc drive strength. If pull-up or pull-down resistors are connected externally to the data I/Os, their values must be kept higher than 20 k $\Omega$  to ensure that they do not contend with the output drivers of the TXB0304. but if the receiver is integrated with the smaller pull down or pull up resistor, below formula can be used for estimation to evaluate the  $V_{OH}$  and  $V_{OL}$ .

$$V_{ol} = V_{CCout} \times \frac{1.5k\Omega}{1.5k\Omega + R_{pu}} \quad (1)$$

$$V_{oh} = V_{CCout} \times \frac{R_{pd}}{1.5k\Omega + R_{pd}}$$

where

- $V_{CCOUT}$  is the output port supply voltage on either  $V_{CCA}$  or  $V_{CCB}$
- $R_{PD}$  is the value of the external pull down resistor
- $R_{PU}$  is the value of the external pull up resistor
- 1.5 k $\Omega$  is the counting the variation of the serial resistor 1k $\Omega$  in the I/O line.

Because of this restriction on external resistors, the TXB0304 should not be used in applications such as I<sup>2</sup>C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the TI [TXS010X](#) series of level translators.

## 9 Application and Implementation

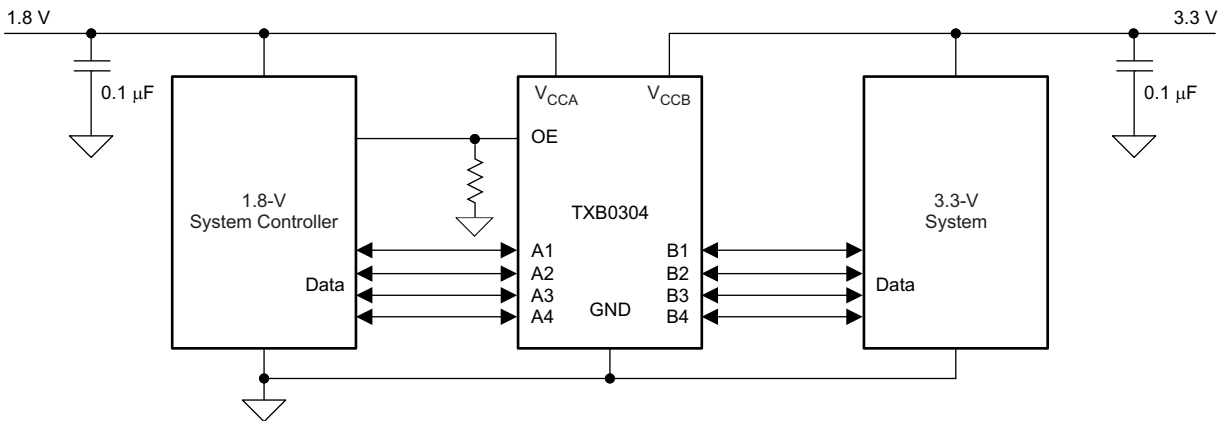
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The TXB0304 can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. It can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI [TXS010X](#) products. Any external pull-down or pull-up resistors are recommended larger than 20 k $\Omega$ .

### 9.2 Typical Application



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**Figure 6. Typical Application Schematic**

#### 9.2.1 Design Requirements

For this design example, use the parameters listed in [Table 1](#).

**Table 1. Design Parameters**

| DESIGN PARAMETERS    | EXAMPLE VALUE  |
|----------------------|----------------|
| Input voltage range  | 0.9 V to 3.6 V |
| Output voltage range | 0.9 V to 3.6 V |

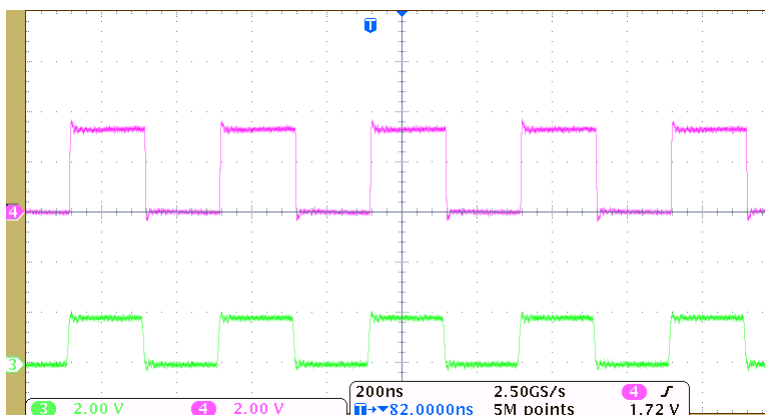
#### 9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the TXB0304 device to determine the input voltage range. For a valid logic high the value must exceed the  $V_{IH}$  of the input port. For a valid logic low the value must be less than the  $V_{IL}$  of the input port.
- Output voltage range
  - Use the supply voltage of the device that the TXB0304 device is driving to determine the output voltage range.
  - Don't recommend to have the external pull-up or pull-down resistors. If mandatory, it is recommended the value should be larger than 20 k $\Omega$ .

- An external pull-down or pull-up resistor decreases the output  $V_{OH}$  and  $V_{OL}$ . Use the below equations in section 8.5.2 to draft estimate the  $V_{OH}$  and  $V_{OL}$  as a result of an external pull-down and pull-up resistor.

### 9.2.3 Application Curve



**Figure 7. Level-Translation of a 2.5-MHz Signal**

## 10 Power Supply Recommendations

During operation, TXB0304 can work at both  $V_{CCA} \leq V_{CCB}$  and  $V_{CCA} \geq V_{CCB}$ . During power-up sequencing, any power supply can be ramped up first. Both the supplies are recommended to be powered down together. The TXB0304 has circuitry that disables all input/output ports when either VCC is switched off ( $V_{CCA/B} = 0$  V).

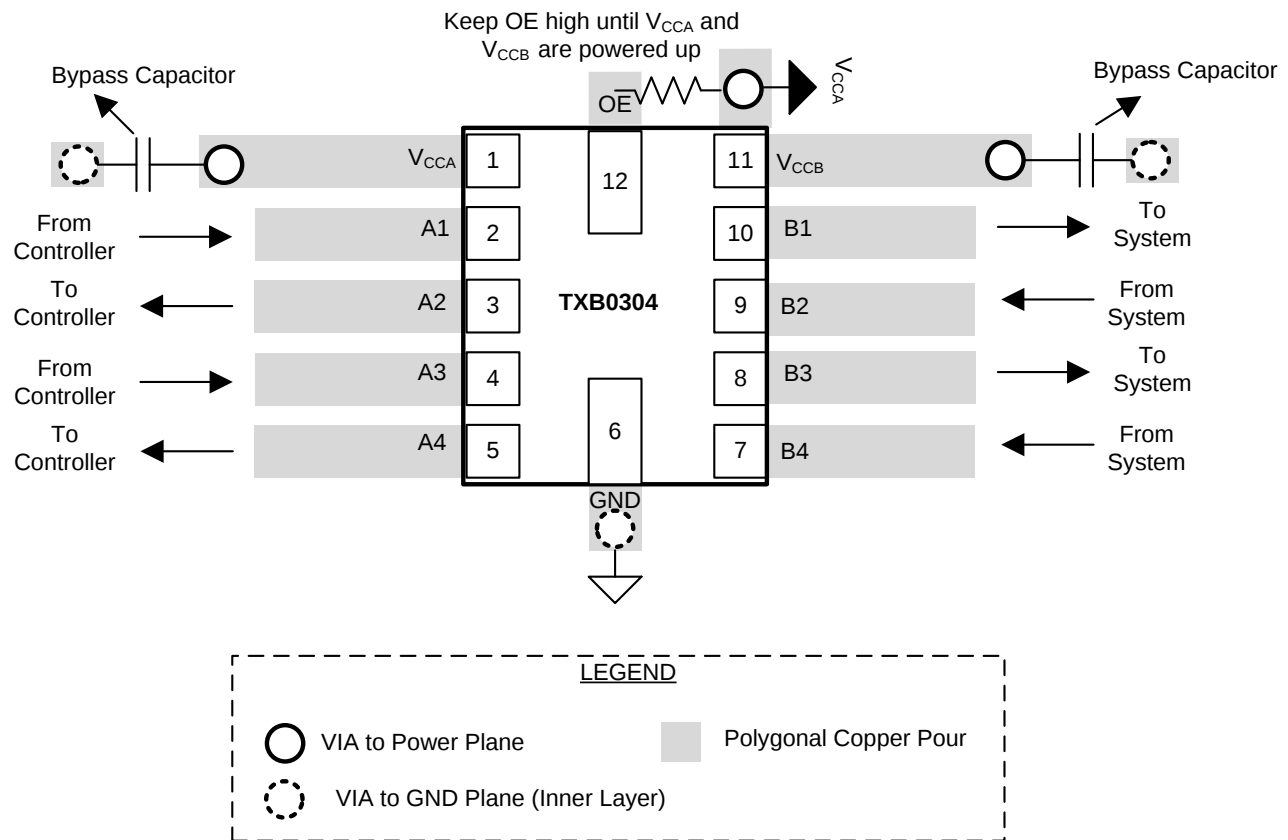
## 11 Layout

### 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended.

- Bypass capacitors should be used on power supplies. And should be placed as close as possible to the  $V_{CCA}$ ,  $V_{CCB}$  pin and GND pin
- Short trace-lengths should be used to avoid excessive loading.
- For long transmission lines, place a series resistor equivalent to the impedance of the transmission lines to avoid signal integrity issues
- PCB signal trace-lengths must be kept short enough so that the round-trip delay of any reflection is less than the one-shot duration, approximately 10 ns, ensuring that any reflection encounters low impedance at the source driver.
- Pullup resistors are not required on both sides for Logic I/O.
- If pullup or pulldown resistors are needed, the resistor value must be over 20 k $\Omega$ .
- 20 k $\Omega$  is a safe recommended value, if the customer can accept higher  $V_{OL}$  or lower  $V_{OH}$ , smaller pull up or pull down resistor is allowed, the draft estimation is  $V_{OL} = V_{ccout} \times 1.5k / (1.5k + R_{pu})$  and  $V_{OH} = V_{ccout} \times R_{pd} / (1.5k + R_{pd})$ .
- If pullup resistors are needed, please refer to the TXS0104 or contact TI.
- For detailed information, refer to application note [SCEA043](#).

## 11.2 Layout Example



**Figure 8. TXB0304 PCB Layout**

## 12 Device and Documentation Support

### 12.1 Device Support

#### 12.1.1 Development Support

For TI TXS010X products, go to [www.ti.com/product/txs0101](http://www.ti.com/product/txs0101).

For the TXB0304 IBIS Model, see [SCEM544](#).

### 12.2 Documentation Support

#### 12.2.1 Related Documentation

For related documentation see the following:

- Application Report, *A Guide to Voltage Translation With TXB-Type Translators*, [SCEA043](#)
- User's Guide, *TXB0304 Evaluation Module*, [SCEU003](#)

### 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.4 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 12.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TXB0304RSVR</a>  | Active        | Production           | UQFN (RSV)   16 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | ZTJ                 |
| TXB0304RSVR.B                | Active        | Production           | UQFN (RSV)   16 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | ZTJ                 |
| <a href="#">TXB0304RUTR</a>  | Active        | Production           | UQFN (RUT)   12 | 3000   LARGE T&R      | Yes         | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM                | -40 to 85    | (737, 73R, 73V)     |
| TXB0304RUTR.B                | Active        | Production           | UQFN (RUT)   12 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | (737, 73R, 73V)     |
| <a href="#">TXBN0304RSVR</a> | Active        | Production           | UQFN (RSV)   16 | 3000   LARGE T&R      | Yes         | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM                | -40 to 85    | ZTK                 |
| TXBN0304RSVR.B               | Active        | Production           | UQFN (RSV)   16 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | ZTK                 |
| <a href="#">TXBN0304RUTR</a> | Active        | Production           | UQFN (RUT)   12 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | 74R                 |
| TXBN0304RUTR.B               | Active        | Production           | UQFN (RUT)   12 | 3000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | 74R                 |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TXB0304RSVR  | UQFN         | RSV             | 16   | 3000 | 177.8              | 12.4               | 2.0     | 2.8     | 0.7     | 4.0     | 12.0   | Q1            |
| TXB0304RUTR  | UQFN         | RUT             | 12   | 3000 | 180.0              | 8.4                | 1.95    | 2.3     | 0.75    | 4.0     | 8.0    | Q1            |
| TXB0304RUTR  | UQFN         | RUT             | 12   | 3000 | 180.0              | 9.5                | 1.9     | 2.3     | 0.75    | 4.0     | 8.0    | Q1            |
| TXBN0304RSVR | UQFN         | RSV             | 16   | 3000 | 177.8              | 12.4               | 2.0     | 2.8     | 0.7     | 4.0     | 12.0   | Q1            |
| TXBN0304RSVR | UQFN         | RSV             | 16   | 3000 | 330.0              | 12.4               | 2.1     | 2.9     | 0.75    | 4.0     | 12.0   | Q1            |
| TXBN0304RUTR | UQFN         | RUT             | 12   | 3000 | 180.0              | 8.4                | 1.95    | 2.3     | 0.75    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TXB0304RSVR  | UQFN         | RSV             | 16   | 3000 | 202.0       | 201.0      | 28.0        |
| TXB0304RUTR  | UQFN         | RUT             | 12   | 3000 | 202.0       | 201.0      | 28.0        |
| TXB0304RUTR  | UQFN         | RUT             | 12   | 3000 | 184.0       | 184.0      | 19.0        |
| TXBN0304RSVR | UQFN         | RSV             | 16   | 3000 | 202.0       | 201.0      | 28.0        |
| TXBN0304RSVR | UQFN         | RSV             | 16   | 3000 | 184.0       | 184.0      | 19.0        |
| TXBN0304RUTR | UQFN         | RUT             | 12   | 3000 | 202.0       | 201.0      | 28.0        |

## GENERIC PACKAGE VIEW

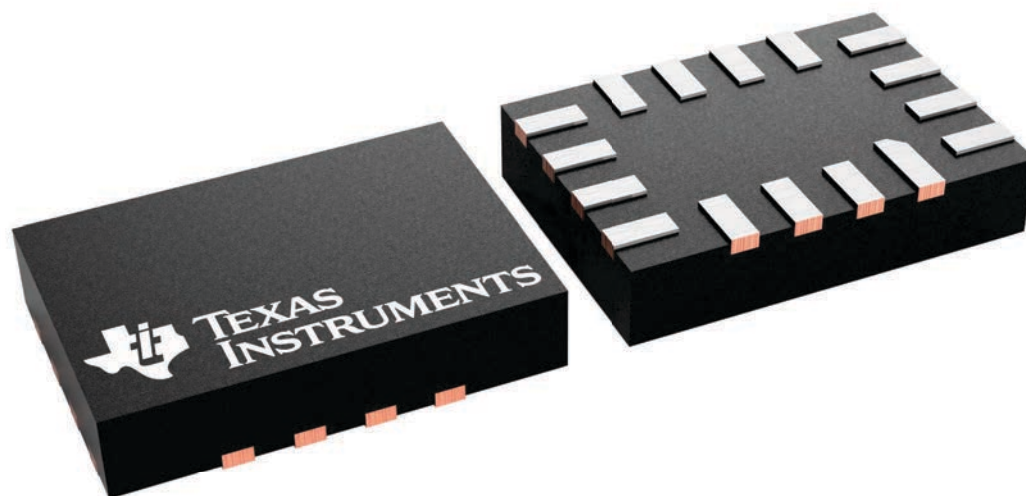
**RSV 16**

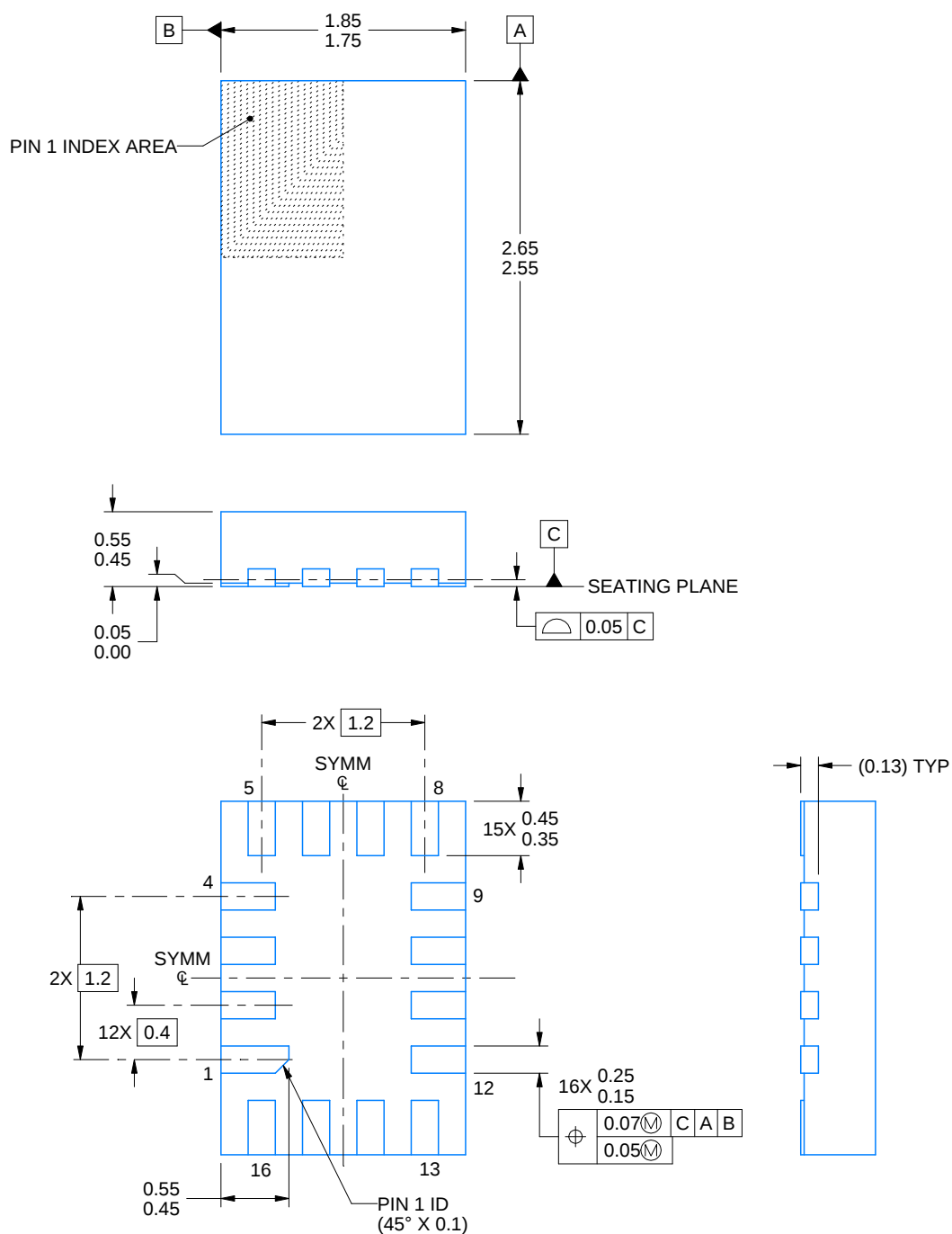
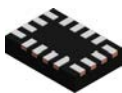
**UQFN - 0.55 mm max height**

1.8 x 2.6, 0.4 mm pitch

ULTRA THIN QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.





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## NOTES:

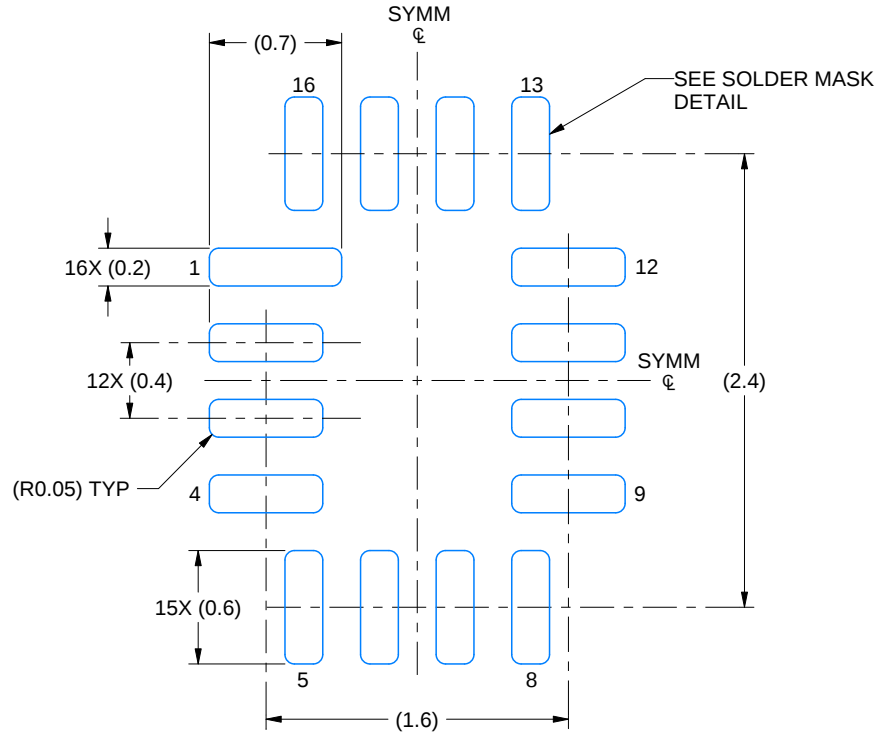
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

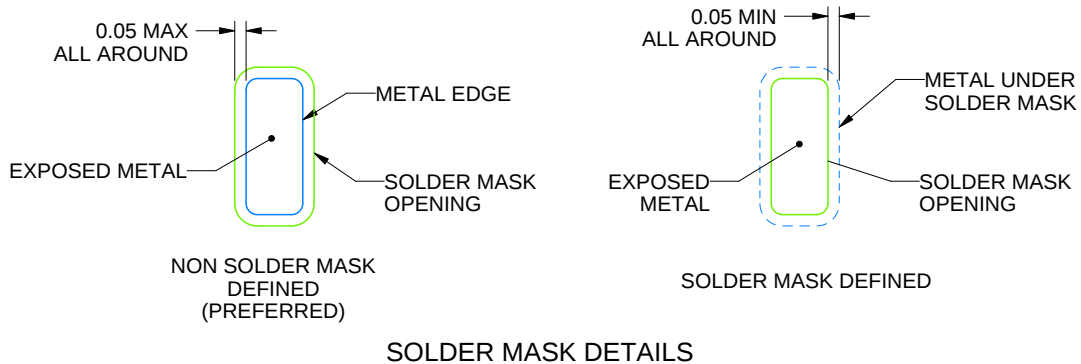
RSV0016A

UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 25X



SOLDER MASK DETAILS

4220314/C 02/2020

NOTES: (continued)

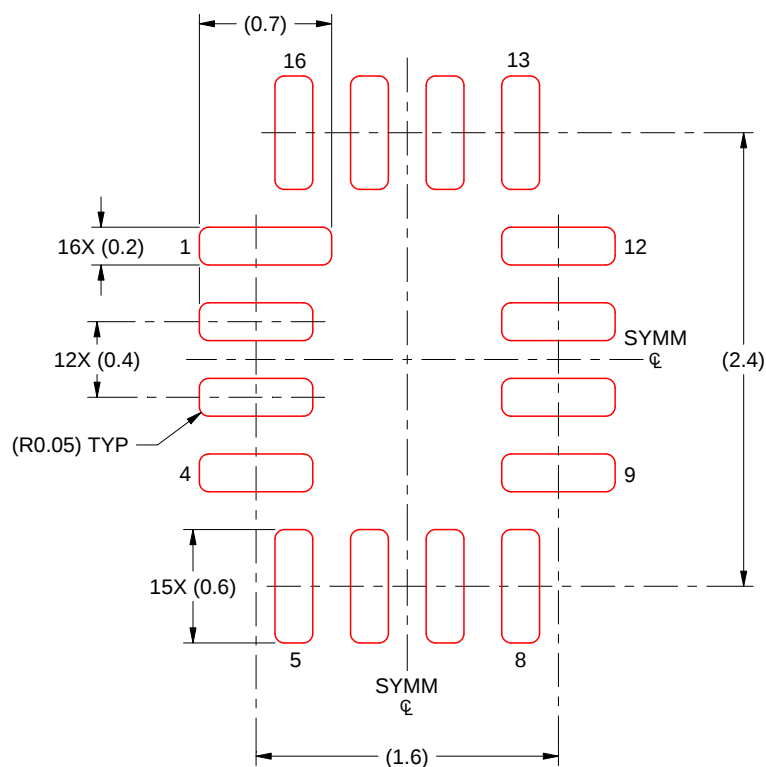
3. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).

# EXAMPLE STENCIL DESIGN

RSV0016A

UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD

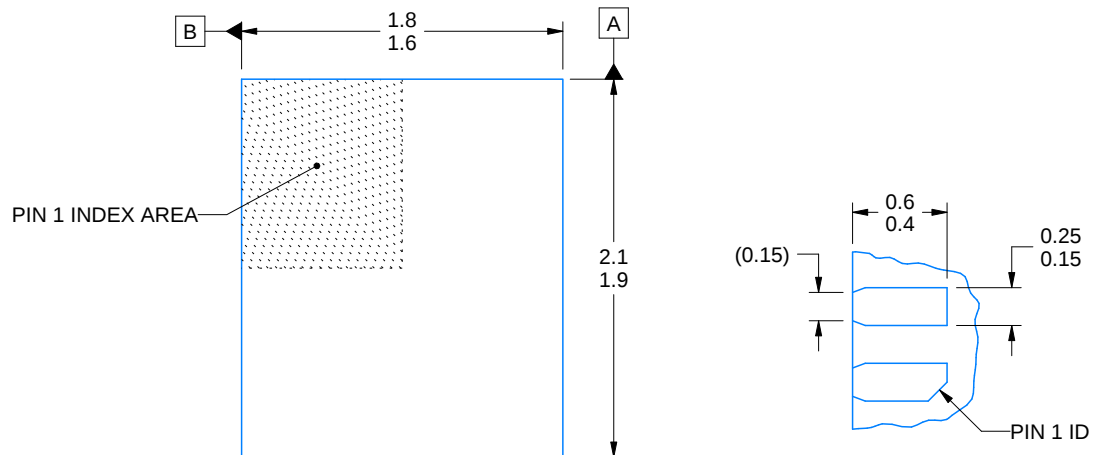
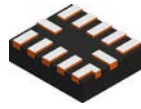


SOLDER PASTE EXAMPLE  
 BASED ON 0.125 MM THICK STENCIL  
 SCALE: 25X

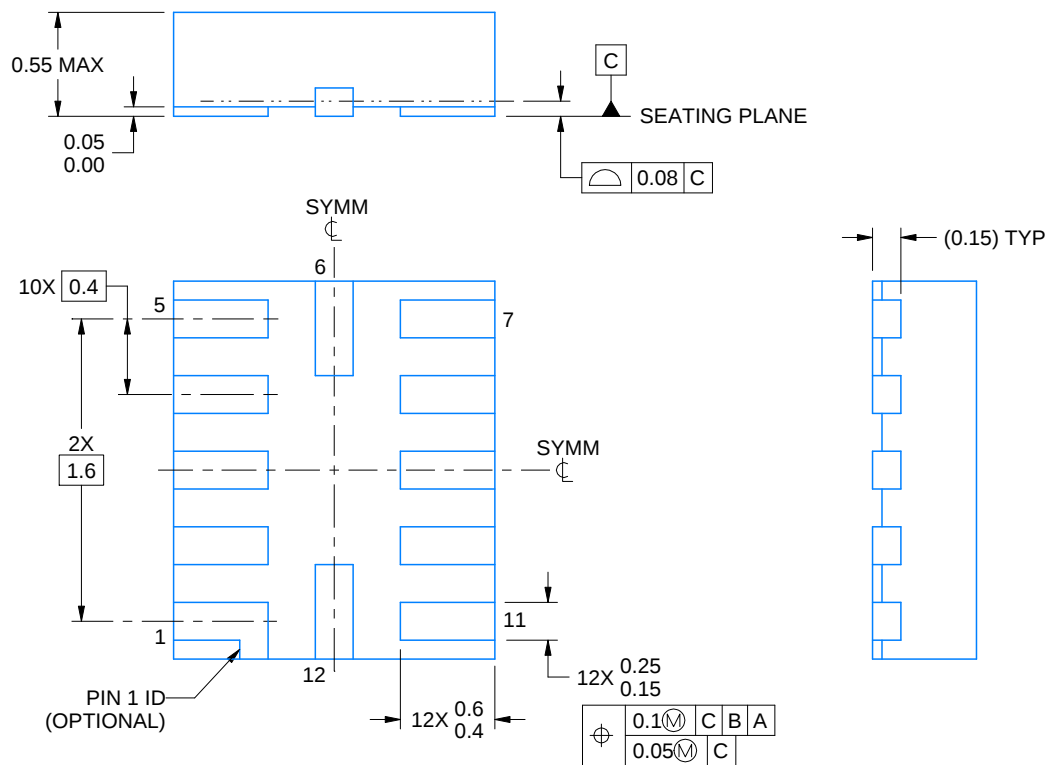
4220314/C 02/2020

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



OPTIONAL TERMINAL &amp; PIN 1 ID



4220310/A 11/2016

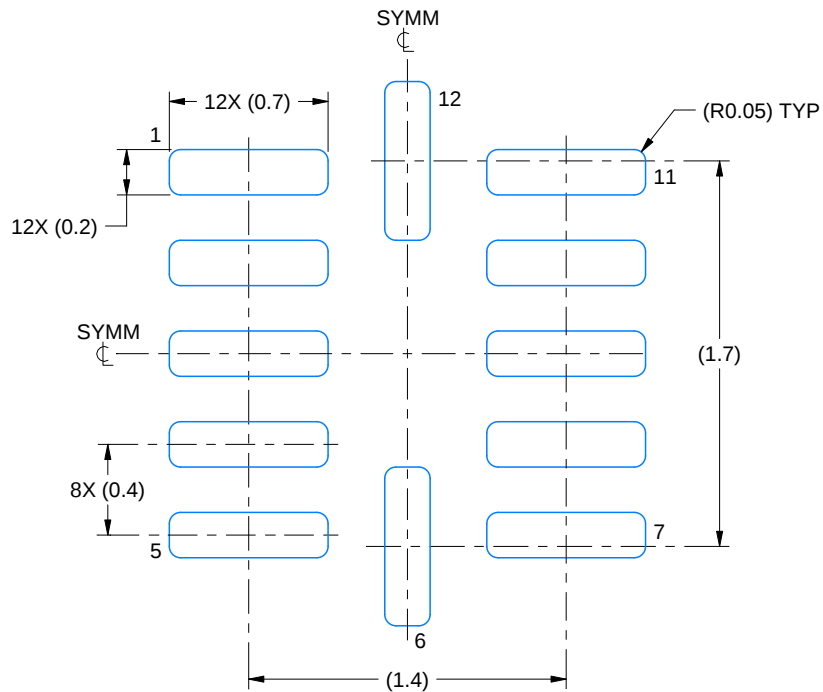
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

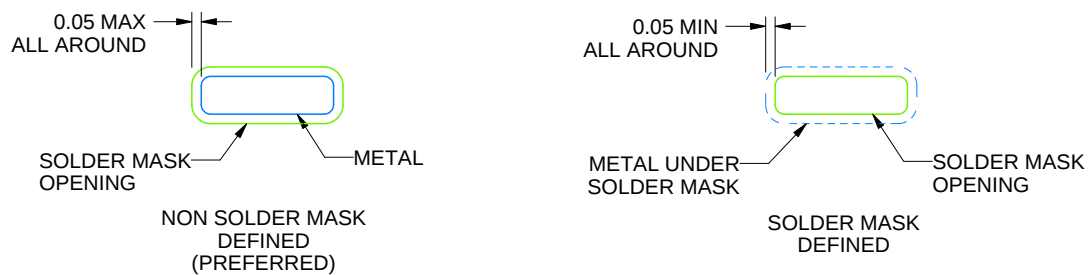
**RUT0012A**

**UQFN - 0.55 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:30X



## SOLDER MASK DETAILS

4220310/A 11/2016

NOTES: (continued)

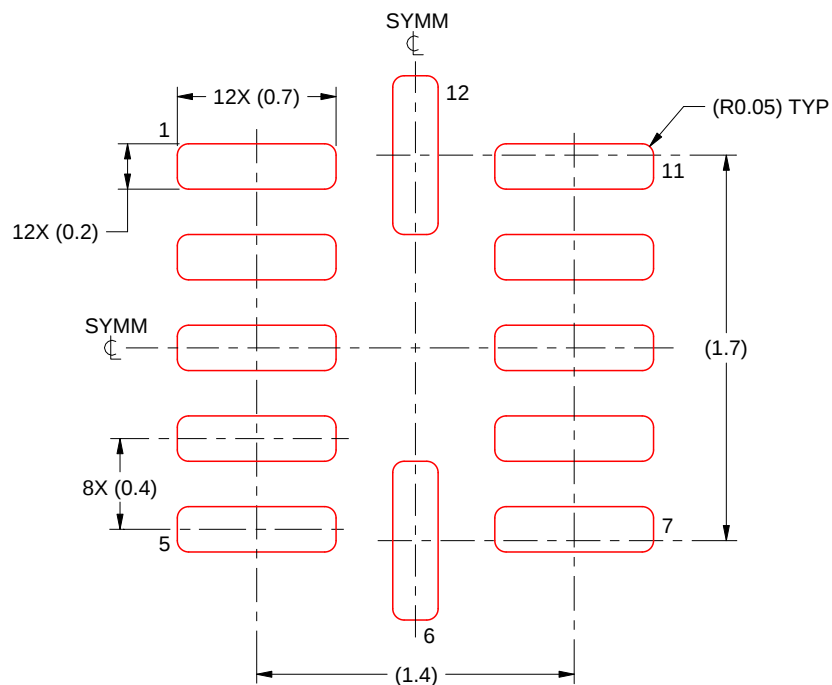
3. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sl原因271](http://www.ti.com/lit/sl原因271)).

## EXAMPLE STENCIL DESIGN

RUT0012A

UQFN - 0.55 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE: 30X

4220310/A 11/2016

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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